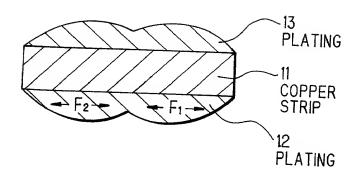
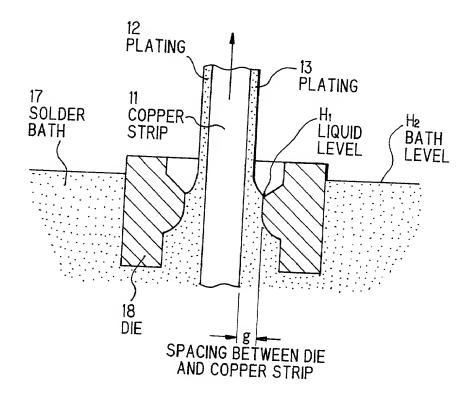


FIG. 2A 13 PLATING APPLIED PRESSURE 14 11 ~ CONNECTION LEAD **COPPER** STRIP 12 —— PLATING SILVER-PLATED PORTION FLOW 15 SILICON 13 PLATING WAFER FIG.2B COPPER STRIP CONNECTION LEAD 12 PLATING -16 SILVER-PLATED PORTION 15 SILICON WAFER

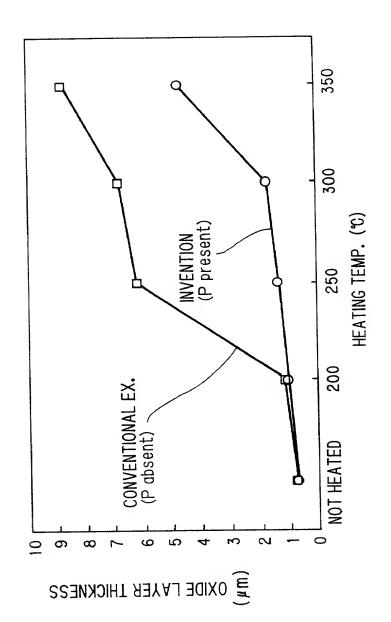
FIG.3



F1G.4



F16.5



F16.6

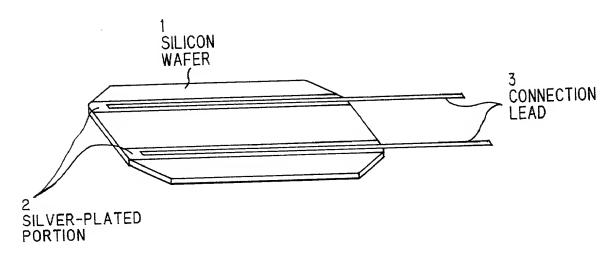
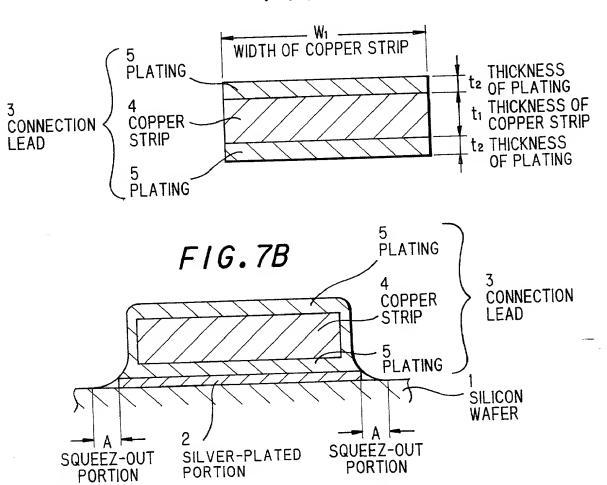


FIG. 7A



11.110